MODEL NO.: TM022HDHT1-00



ISSUED DAT	E: <u>20</u>	09-11-3						
VERSION	: <u>Ve</u>	r 0.0						
	-	ecificatio Specifica						
Customer :								
Approved by			Notes					
	SHANGHAI TIANMA Confirmed :							
prepared by	Check	ed by	Approved by					

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This technical specification is subjected to change without notice







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Record of Revision

Rev	Issued Date	Description
0.0	2009-11-3	Provisional spec release



1 General specifications

	F	eature	Spec
	Size		2.2 inch
	Resolutio	n	240(RGB) X 320
	Interface		RGB 18 bits+4 SPI
	Color De	oth	262K
	Technolo	gy type	a-si TFT
Diamley Chee	Pixel pitcl	h (mm)	0.141x0.141
Display Spec.	Pixel Cor	ifiguration	R.G.B. Vertical Stripe
	Display M	lode	ECB Transflective
	Surface T	reatment(Up Polarizer)	Clear type (3H)
	Surface T	reatment(TSP)	Clear type (3H)
	Viewing [Direction	12 o'clock
	Gray Scale Inversion Direction		6 o'clock
	DIM.	LCM (W x H x D) (mm)	40.6x56.6x2.70
Manhaniaal	Active Are	ea(mm)	33.84 x45.12
Mechanical Characteristics	With /Wit	hout TSP	Without TSP
	Weight (g	ram)	TBD
	LED Num	nbers	4 LEDs (serial)

Note 1: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2: Requirements on Environmental Protection: RoHS



2 Input/Output terminals

2.1 TFT LCD Panel

Recommended connector: FH23-39S-0.3SHW (HIROSE)

No	Symbol	I/O	Description	Remarks
1	VL1 (LED+)	I	Power supply for LED(High voltage)	
2	VL2 (LED-)	I	Power supply for LED(Low voltage)	
3	GND	Р	Ground	
4	VDD	Р	Power supply of gate driver(high level)	
5	GND	Р	Ground	
6	VSYNC	I	Vertical sync. signal	
7	RESET	I	Reset Enable	
8	GND	Р	Ground	
9	CS	I	SPI Chip select	
10	SDO	0	SPI serial Data output	
11	SDI	I	SPI serial Data input	
12	GND	Р	Ground	
13	SCL	I	SPI serial interface clock	
14	GND	Р	Ground	
15	B5	I	Blue data signal	
16	B4	I	Blue data signal	
17	B3	I	Blue data signal	
18	B2	I	Blue data signal	
19	B1		Blue data signal	
20	B0	I	Blue data signal	
21	ENABLE	I	Data enable signal	
22	HSYNC	I	Horizontal sync signal	
23	GND	Р	Ground	
24	DCLK		Data sampling clock signal	
25	GND	Р	Ground	
26	G5	ı	Green data signal	
27	G4	ı	Green data signal	
28	G3	I	Green data signal	
29	G2	I	Green data signal	
30	G1	1	Green data signal	
31	G0	I	Green data signal	
32	GND	Р	Ground	
33	R5	I	Red data signal	
34	R4	I	Red data signal	
35	R3	I	Red data signal	
36	R2	I	Red data signal	
37	R1	1	Red data signal	
38	R0	1	Red data signal	
39	GND	Р	Ground	

Note2-1: I/O definition:

I----Input



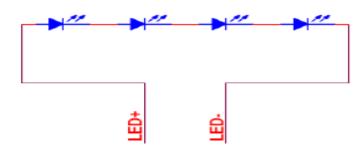


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O---Output

P----Power

Note 2-2: The figure below shows the connection of backlight LED.





3 Absolute maximum ratings

3.1 Driving TFT LCD Panel

(VSS=0, Ta = 25°C)

Item	Symbol	MIN	MAX	Unit	Remark
Logic Supply Voltage	VDD	-0.3	3. 3	V	
Input Signal Voltage	R0~R5,G0~G5,B0~B5, ENABLE,DCLK,HSYNC, VSYNC,/CS,SCL,SDI,SDO/RESET	-0.3	VDD3 +0.5	V	
Back Light Forward Current	I _{LED}	1	20	mA	
Operating Temperature	T_{OPR}	-20	70	$^{\circ}\!\mathbb{C}$	
Storage Temperature	T_{STG}	-30	80	$^{\circ}\!\mathbb{C}$	

Note 1: Symbol VDD3 rate is -0.3 to 5.0 and The parameter is for S6D04H0X02-B0C1 only.



4 Electrical characteristics

4.1 Driving TFT LCD Panel

(VSS=0,Ta=25°C)

(100 0,14 20							,,
Parameter		Symbol	MIN	TYP	MAX	Unit	Remark
Digital sup	ply Voltage	VDD	2.52	2.8	3.08	٧	
Gate or	n voltage	VGH	13.5	15.0	16.5	V	
Gate off voltage		VGL	-11.0	-10.0	-9.0	V	
Input Signal	Low Level	V _{IL}	0	-	0.3*VDD	V	
Voltage	High Level	V _{IH}	0.7*VDD	-	VDD	V	
Output Signal	Low Level	VOL	0.0	-	0.2 VDD	V	
Voltage	High Level	VOH	0.8VDD	-	VDD	V	
Current of VDD Power supply		I _{CC}	-	TBD	-	mA	Note 1

Note1:To test the current dissipation, use "all Black Pattern".

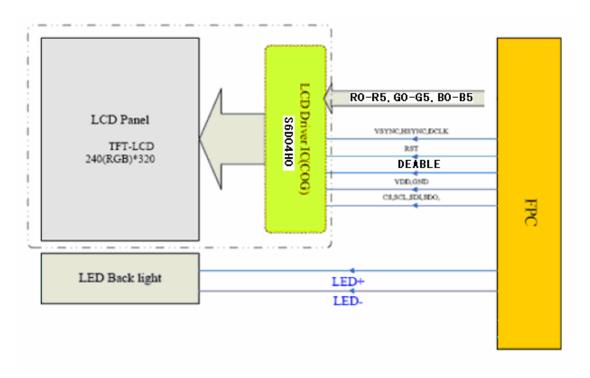
4.2 Driving Backlight Ta=25℃

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	I _F		20		mA	=5
Forward Voltage	V_{F}		12.8		\ \ /	4 LEDs serial
Power Consumption	W_{BL}		256		mW	





4.3 Block Diagram





5 Timing chart

5.1 RGB INTERFACE CHARACTERISTICS

5.2.1 RGB Interface Timing

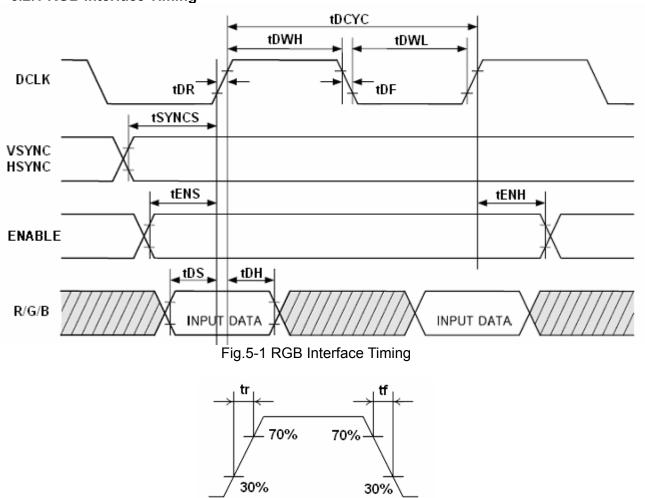


Fig.5-2 Input signal's rise and fall times

Tab.5-1 RGB Interface AC Characteristics

(VSHD=2.4~3.3V,Ta=-40~+85°C)

Parameter	Description	Min	Max	Unit	Remark
tDCYC	DCLK period	100	-	ns	
tDWL	DCLK pluse width low	50	-	ns	
tDWH	DCLK pluse width high	50	-	ns	
tDR/tDF	DCLK rising/falling time	-	20	ns	
tSYNCS	VSYNC,HSYNC setup	30	-	ns	Note
tENS	ENABLE setup	50	-	ns	
tENH	ENABLE hold	50	-	ns	
tDS	Input Data setup	50	-	ns	
tDH	Input Data hold	50	-	ns	



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TM022HDHT1-00

tf	signal's rise time	-	15	ns	
tr	signal's fall time	-	15	ns	

Note:

- 1. VSYNC Low Pulse Width ≥ 1H;
- 2. HSYNC Low Pluse Width ≥1DCLK

5.2.2 Recommend RGB Interface Timing

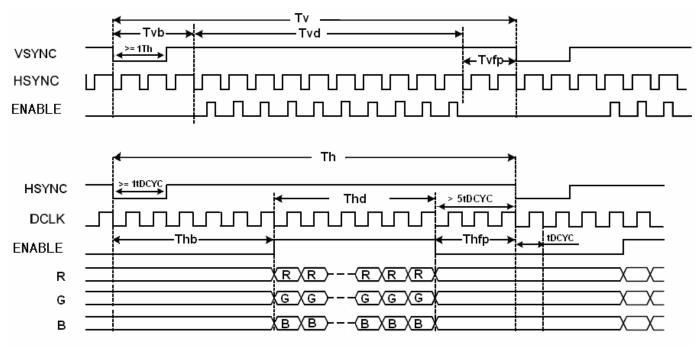


Fig.5-3 Recommend RGB Interface Timing

Tab.5-2 Recommend Input Timing (DCLK, HSYNC, VSYNC, ENABLE) (VSHD=2.4~3.3V,Ta=-40~+85°C)

Parameter	Symbol	Symbol	Min.	Тур.	Max.	Unit	Remark
DCLK	DCLK frequency	fDCYC	-	5.64	10	MHz	
DOLK	DCLK period	tDCYC	100	177.15	-	ns	
	Horizontal	Thd		240			
HSYNC	1horizontalline	Th	259	280	-	Tclk	
HSYNC	Horizontal blank	Thb	3	20	-	ICIK	
	Horizontal front porch	Thfp	15	20	-		
	Vertical display area	Tvd		320			
VSYNC	Vsync period time	Tv	325	336	-	Th	
VSYNC	Vsync blank	Tvb	2	8	-	111	
	Vsync Front porch	Tvfp	2	8	-		



5.2 3-WIRE 9-BIT SERIAL INTERFACE

5.2.1 3-Wire 9-Bit data serial interface write mode

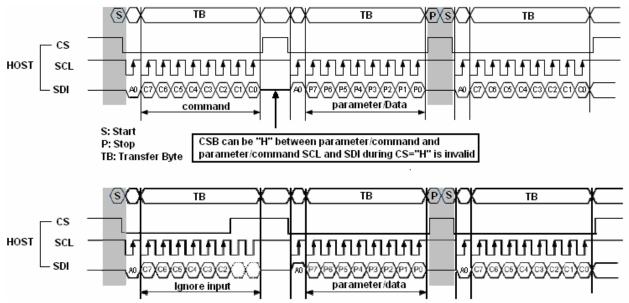


Figure. 5-4 3-Wire 9-Bit Serial Interface I Bus Protocol, Write to Register or Display RAM Note: A0=0, Transfer Command; A0=1, Transfer Data.

5.2.2 3-Wire 9-Bit data serial interface read 1-byte mode

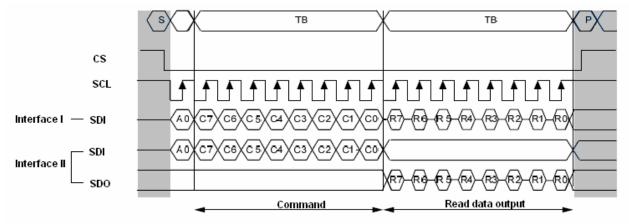


Figure. 5-5 3-Wire 9-Bit Serial Interface I/II Bus Protocol, Read 1-Byte From Register Note: A0=0, Transfer Command; A0=1, Transfer Data.



5.2.2 3-Wire 9-Bit data serial interface read multi-byte mode

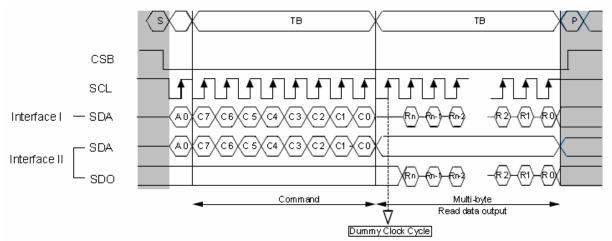


Figure. 5-6 3-Wire 9-Bit Serial Interface I/II Bus Protocol, Read Muti-Byte From Register Note: A0=0, Transfer Command; A0=1, Transfer Data.

5.2.4 3-Wire 9-Bit serial interface Timing

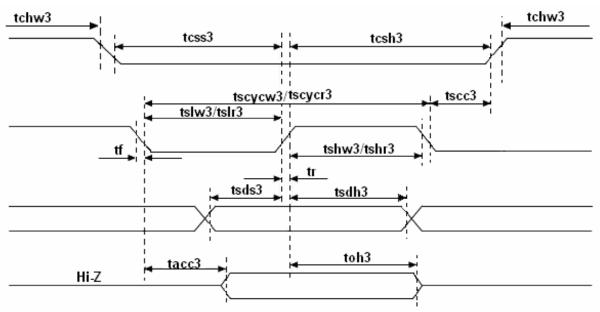


Fig.5-7 AC Characteristics of 3-Wire 9-Bit Serial Interface timing



Tab.5-3 AC Characteristics of 3-Wire 9-Bit Serial Interface

(VSHD=2.4~3.3V,Ta=-40~+85°C)

Parameter	Symbol	Conditions	Min	Max	Unit	Remark
Serial Clock Cycle(Write)	tscycw3	SCL	100	-	ns	
SCL "H" pluse width(Write)	tshw3	SCL	35	-	ns	
SCL "L" pluse width(Write)	tslw3	SCL	35	-	ns	
Data setup time(Write)	tsds3	SDA	30	-	ns	
Data hold time(Write)	tsdh3	SDA	30	-	ns	
Serial Clock Cycle(Read)	tscycr3	SCL	150	-	ns	
SCL "H" pluse width(Read)	tshr3	SCL	60	-	ns	
SCL "L" pluse width(Read)	tslr3	SCL	60	-	ns	
Access time	tacc3	SDO(Note2)	10	50	ns	
Output disable time	toh3	SDO(Note2)	15	50	ns	
CS "H" pluse width	tchw3	CS	40	-	ns	
CS-SCL time	tcssw3	CS (Write)	60	-	ns	
CS-SCL time	tcshw3	CS (Write)	65	-	ns	

Note: For maximum CL=30pF, for minimum CL=8pF

5.3 Reset Timing

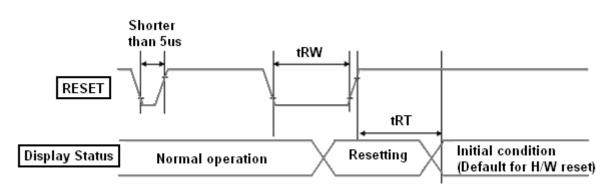


Fig.5-8 Reset timing

Tab.5-4 Reset input timing

Parameter	Symbol	MIN	TYP	MAX	Unit	Remark
	tRW	10	-	1	us	-
RESET	tRT	-	-	5	ms	note 1
		-	-	120	ms	note 2

Note1: When Reset applied during Sleep In Mode. Note2: When Reset applied during Sleep Out Mode.



5.4. POWER ON/OFF SEQUENCE

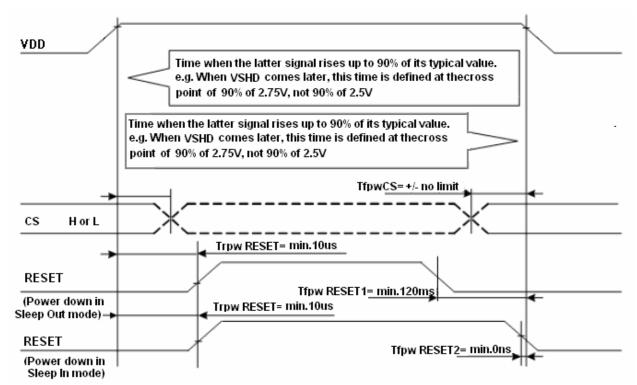


Fig.6-1 Power On/Off Sequence

Note 1. Tfpw RESET1 is applied to RESET falling in the sleep out mode.

Note 2. Tfpw RESET2 is applied to RESET falling in the sleep in mode.





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6 Optical characteristics

6.1 Optical Specification

Ta=25°C

Item		Symbol	Condition	Min	Тур.	Max.	Unit	Remark
View Angles		θТ		40	45	-		
		⊖В	CR≧10	40	45	-	Degree	Note 2
		θL		40	45	-	Degree	
		θR		40	45	-		
Contrast Ratio		CR	θ=0°	200	350	-		Note1 Note3
Response Time		Ton	25 ℃	-	35		ms	Note1
		Toff	200					Note4
Chromaticity	White	Х	Brightness is on		TBD			Note5,
	VVIIILE	у			TBD			Note1
Uniformity		U			80	-	%	Note1 Note6
NTSC				-	30	-	%	Note 5
Luminance		L		145	195	-	cd/m ²	Note1 Note7
Reflectance					6		%	Note8

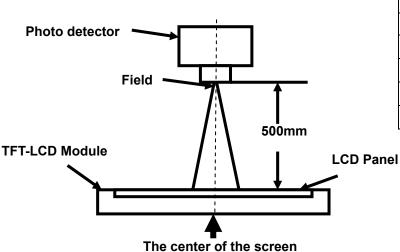
Test Conditions:

- 1. VDD=2.8V, I_L=20mA(LED current), the ambient temperature is 25℃.
- 2. The test systems refer to Note 1, Note 2 and Note 8.



Note 1: Definition of optical measurement system.

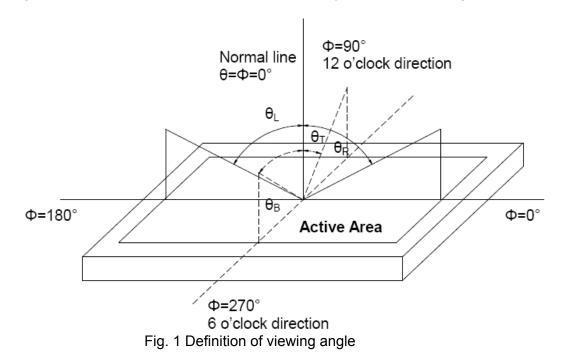
The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Item	Photo detector	Field	
Contrast Ratio			
Luminance	SR-3A	1°	
Chromaticity			
Lum Uniformity			
Response Time	BM-7A	2°	

Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).





Note 3: Definition of contrast ratio

Contrast ratio (CR) = $\frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}}$

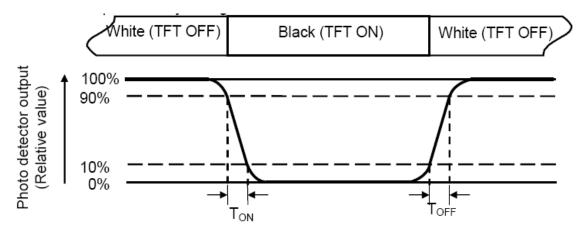
"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.



Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/Lmax

L----- Active area length W----- Active area width

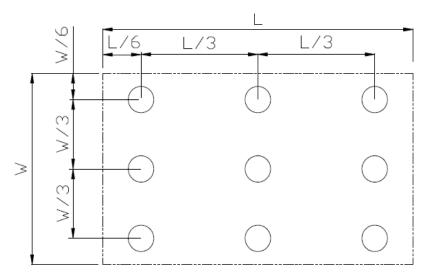


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

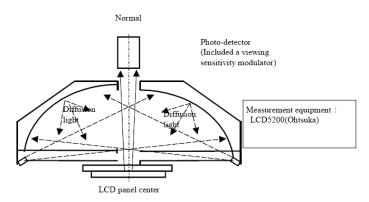
Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.

Note 8: Definition of Reflectance measurement system

Note 5) Reflectance is defined as follows:





7 Environmental / Reliability tests

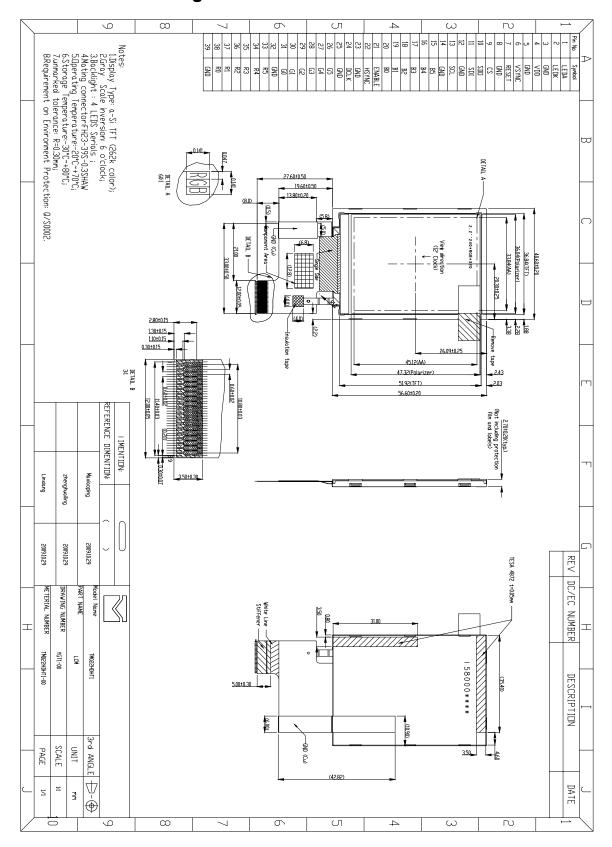
No	Test Item	Condition	Remarks
1	High Temperature Operation	·	Note1 IEC60068-2-2,GB2423.2—89
2	Low Temperature Operation	Ta=-20°ℂ , 240hrs	IEC60068-2-1 GB2423.1—89
3	High Temperature Storage		IEC60068-2-2, GB2423.2—89
4	Low Temperature Storage		IEC60068-2-1 GB2423.1—89
5	High Temperature & High Humidity Storage	+60°C, 90% RH max,240 hours	Note2 IEC60068-2-3, GB/T2423.3—2006
6	Thermal Shock (Non-operation)	-30°C 30 min∼+80°C 30 min, Change time:5min, 20 Cycle	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22—87
7	Electro Static Discharge (Operation)	C=150pF, R=330 Ω , 5points/panel Air:± 8KV, 5times; Contact:± 4KV, 5 times; (Environment: 15 $^{\circ}$ C $^{\circ}$ 35 $^{\circ}$ C, 30% $^{\circ}$ 60%, 86Kpa $^{\circ}$ 106Kpa)	IEC61000-4-2 GB/T17626.2—1998
8		Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 1 hours for each direction of X.Y.Z.(3 hours for total)	IEC60068-2-6 GB/T2423.10—1995
9	Shock (Non-operation)	60G 6ms, \pm X, \pm Y, \pm Z 3times for each direction	IEC60068-2-27 GB/T2423.5—1995
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8—1995

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.



8 Mechanical drawing







9 Packing drawing(TBD)



10 Precautions for use of LCD modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol。
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - 10.1.8.1 Be sure to ground the body when handling the LCD Modules.
 - 10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
 - 10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - 10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
 - 10.2 Storage precautions
- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0°C ~ 40°C Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
 - 10.3 Transportation Precautions:

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.